

# **MOSFET**

## OptiMOS<sup>™</sup> 5 Power-Transistor, 150 V

### **Features**

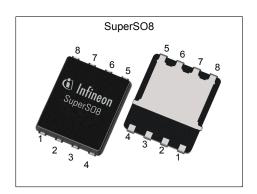
- N-channel, logic level
- Very low on-resistance R<sub>DS(on)</sub>
  Superior thermal resistance
- 100% avalanche tested
- Pb-free lead plating; RoHS compliant
  Halogen-free according to IEC61249-2-21

### **Product validation**

Fully qualified according to JEDEC for Industrial Applications

Table 1 **Key Performance Parameters** 

- and the state of							
Parameter	Value	Unit					
<b>V</b> <sub>DS</sub>	150	V					
R <sub>DS(on),max</sub>	8.8	mΩ					
I <sub>D</sub>	87	A					
Qoss	94	nC					
Q <sub>G</sub> (0V10V)	40	nC					











Type / Ordering Code	Package	Marking	Related Links
BSC088N15LS5	PG-TDSON-8	088N15LS	-

# OptiMOS<sup>™</sup> 5 Power-Transistor, 150 V BSC088N15LS5



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# OptiMOS<sup>™</sup> 5 Power-Transistor, 150 V **BSC088N15LS5**



# 1 Maximum ratings at $T_A$ =25 °C, unless otherwise specified

Table 2 **Maximum ratings** 

Bassassatas	0	Values				N / / T / O   11/1
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current <sup>1)</sup>	I <sub>D</sub>	- - -	- - -	87 55 47 11.7	A	V <sub>GS</sub> =10 V, T <sub>C</sub> =25 °C V <sub>GS</sub> =10 V, T <sub>C</sub> =100 °C V <sub>GS</sub> =4.5 V, T <sub>C</sub> =100 °C V <sub>GS</sub> =10V, T <sub>A</sub> =25 °C, R <sub>thJA</sub> =50 °C/W <sup>2</sup> )
Pulsed drain current <sup>3)</sup>	I <sub>D,pulse</sub>	-	-	348	Α	T <sub>C</sub> =25 °C
Avalanche energy, single pulse <sup>4)</sup>	<b>E</b> AS	-	-	85	mJ	$I_{\rm D}$ =50 A, $R_{\rm GS}$ =25 $\Omega$
Gate source voltage	V <sub>GS</sub>	-20	-	20	V	-
Power dissipation	P <sub>tot</sub>	-	-	139 2.5	W	T <sub>C</sub> =25 °C T <sub>A</sub> =25 °C, R <sub>thJA</sub> =50 °C/W <sup>2)</sup>
Operating and storage temperature	T <sub>j</sub> , T <sub>stg</sub>	-55	-	150	°C	-

#### 2 Thermal characteristics

#### Table 3 Thermal characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
raiailletei	Symbol	Min.	Тур.	Max.	Ullit	Note / Test Condition
Thermal resistance, junction - case, bottom	R <sub>thJC</sub>	-	-	0.9	°C/W	-
Thermal resistance, junction - case, top	R <sub>thJC</sub>	-	-	20	°C/W	-
Thermal resistance, junction - ambient, 6 cm² cooling area <sup>2)</sup>	R <sub>thJA</sub>	-	-	50	°C/W	-

<sup>&</sup>lt;sup>1)</sup> Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.  $^{2)}$  Device on 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm $^{2}$  (one layer, 70  $\mu$ m thick) copper area for drain

connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

<sup>&</sup>lt;sup>4)</sup> See Diagram 13 for more detailed information

# OptiMOS<sup>™</sup> 5 Power-Transistor, 150 V BSC088N15LS5



## 3 Electrical characteristics

at T<sub>j</sub>=25 °C, unless otherwise specified

**Table 4** Static characteristics

D	0		Values			
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	150	-	-	V	V <sub>GS</sub> =0 V, I <sub>D</sub> =1 mA
Gate threshold voltage	V <sub>GS(th)</sub>	1.3	1.8	2.3	V	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =107 μA
Zero gate voltage drain current	I <sub>DSS</sub>	-	0.1 10	1.0 100	μΑ	V <sub>DS</sub> =120 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =25 °C V <sub>DS</sub> =120 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =125 °C
Gate-source leakage current	$I_{\mathrm{GSS}}$	-	10	100	nA	V <sub>GS</sub> =20 V, V <sub>DS</sub> =0 V
Drain-source on-state resistance	R <sub>DS(on)</sub>	-	7.6 9.3	8.8 12	mΩ	V <sub>GS</sub> =10 V, I <sub>D</sub> =46 A V <sub>GS</sub> =4.5 V, I <sub>D</sub> =23 A
Gate resistance	R <sub>G</sub>	-	0.9	1.35	Ω	-
Transconductance	<b>g</b> fs	-	81	-	S	V <sub>DS</sub>   ≥2   I <sub>D</sub>   R <sub>DS(on)max</sub> , I <sub>D</sub> =46 A

Table 5 Dynamic characteristics

Davamatar	Cumbal	Values			11!4	Nata / Tank Canadikian
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance	Ciss	-	2700	3500	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =75 V, <i>f</i> =1 MHz
Output capacitance <sup>1)</sup>	Coss	-	680	880	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =75 V, f=1 MHz
Reverse transfer capacitance <sup>1)</sup>	C <sub>rss</sub>	-	19	33	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =75 V, <i>f</i> =1 MHz
Turn-on delay time	t <sub>d(on)</sub>	-	6.9	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =46 A, $R_{\rm G,ext}$ =1.6 $\Omega$
Rise time	t <sub>r</sub>	-	2.4	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =46 A, $R_{\rm G,ext}$ =1.6 $\Omega$
Turn-off delay time	$t_{ m d(off)}$	-	20.0	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =46 A, $R_{\rm G,ext}$ =1.6 $\Omega$
Fall time	t <sub>f</sub>	-	3.5	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =46 A, $R_{\rm G,ext}$ =1.6 $\Omega$

Table 6 Gate charge characteristics<sup>2)</sup>

Parameter	Council of	Values			11:4	Nata / Tast Candition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q <sub>gs</sub>	-	8.8	-	nC	$V_{DD}$ =75 V, $I_{D}$ =46 A, $V_{GS}$ =0 to 4.5 V
Gate charge at threshold	Q <sub>g(th)</sub>	-	4.8	-	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =46 A, $V_{\rm GS}$ =0 to 4.5 V
Gate to drain charge <sup>1)</sup>	Q <sub>gd</sub>	-	7.9	11.9	nC	V <sub>DD</sub> =75 V, I <sub>D</sub> =46 A, V <sub>GS</sub> =0 to 4.5 V
Switching charge	Q <sub>sw</sub>	-	11.9	-	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =46 A, $V_{\rm GS}$ =0 to 4.5 V
Gate charge total <sup>1)</sup>	Qg	-	21	26	nC	V <sub>DD</sub> =75 V, I <sub>D</sub> =46 A, V <sub>GS</sub> =0 to 4.5 V
Gate plateau voltage	V <sub>plateau</sub>	-	3.3	-	V	V <sub>DD</sub> =75 V, I <sub>D</sub> =46 A, V <sub>GS</sub> =0 to 4.5 V
Gate charge total <sup>1)</sup>	Qg	-	40	50	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =46 A, $V_{\rm GS}$ =0 to 10 V
Output charge <sup>1)</sup>	Qoss	-	94	125	nC	V <sub>DS</sub> =75 V, V <sub>GS</sub> =0 V

 $<sup>^{1)}</sup>$  Defined by design. Not subject to production test.  $^{2)}$  See "Gate charge waveforms" for parameter definition

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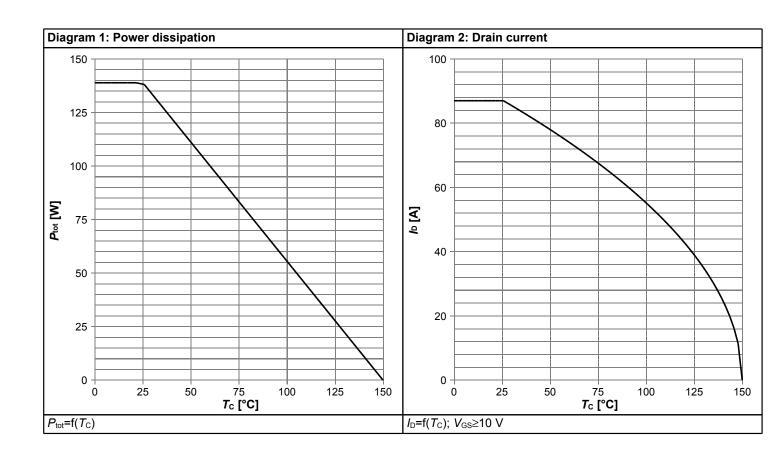


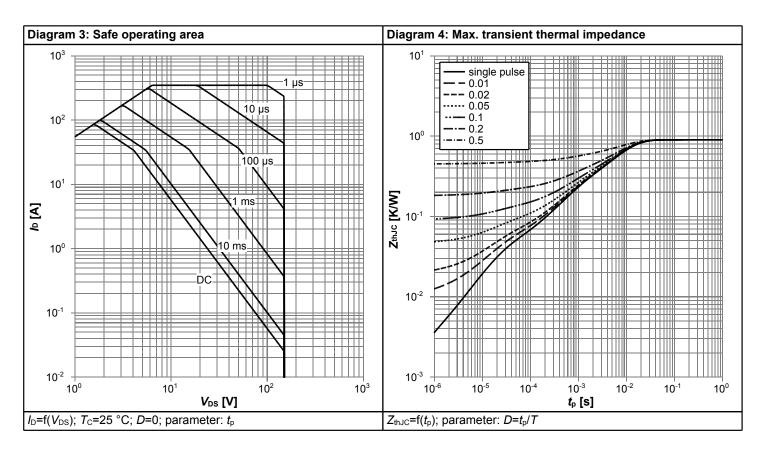
## Table 7 Reverse diode

Davamatar	Cumbal		Values			Nata / Taat Canditian
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continuous forward current	Is	-	-	87	Α	T <sub>C</sub> =25 °C
Diode pulse current	I <sub>S,pulse</sub>	-	-	348	Α	T <sub>C</sub> =25 °C
Diode forward voltage	V <sub>SD</sub>	-	0.83	1.2	V	V <sub>GS</sub> =0 V, I <sub>F</sub> =44 A, T <sub>j</sub> =25 °C
Reverse recovery time <sup>1)</sup>	t <sub>rr</sub>	-	22.5	45.0	ns	V <sub>R</sub> =75 V, I <sub>F</sub> =46 A, d <i>i</i> <sub>F</sub> /d <i>t</i> =100 A/μs
Reverse recovery charge <sup>1)</sup>	Qrr	-	11.3	22.6	nC	V <sub>R</sub> =75 V, I <sub>F</sub> =46 A, d <i>i</i> <sub>F</sub> /d <i>t</i> =100 A/μs

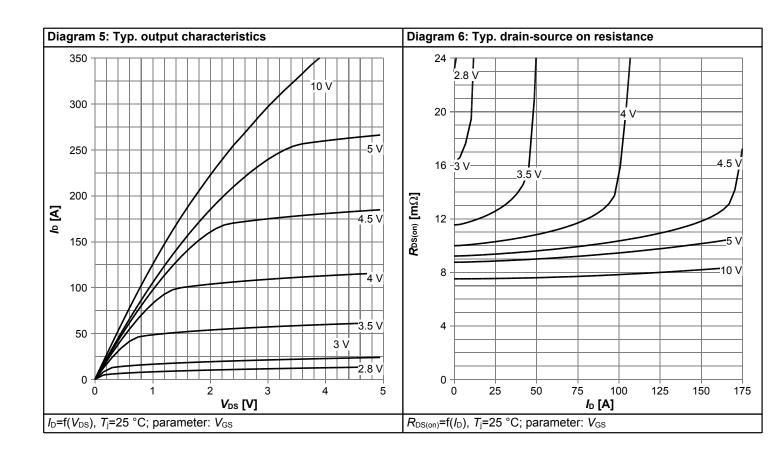


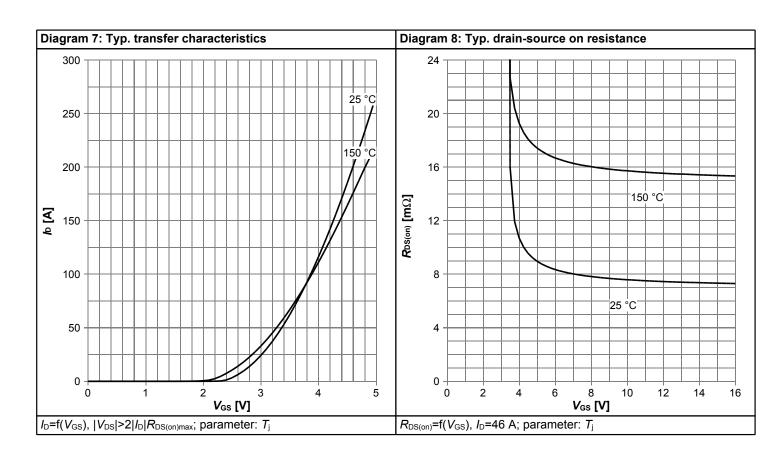
# 4 Electrical characteristics diagrams



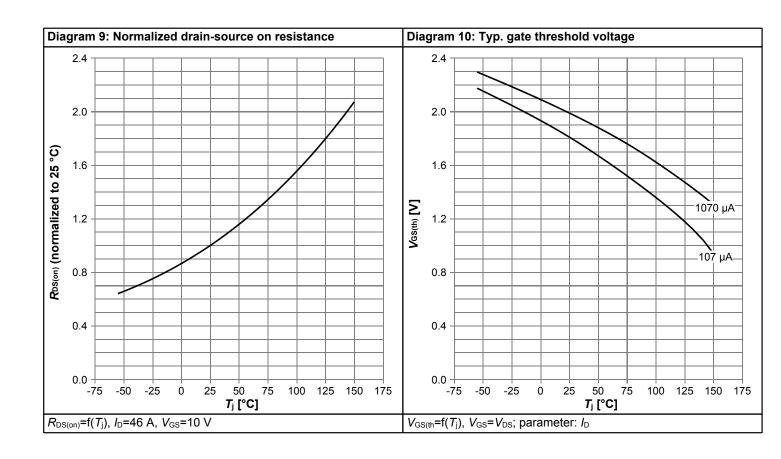


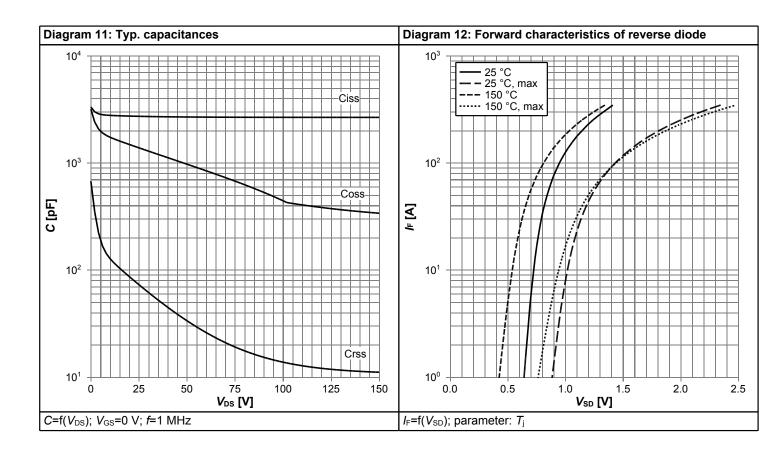




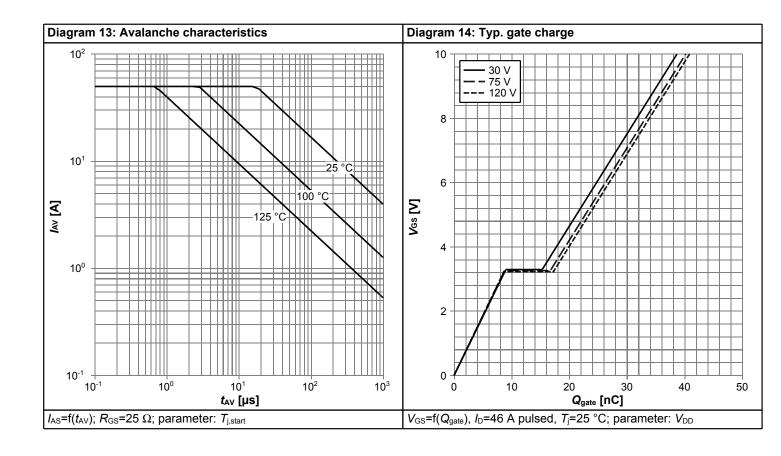


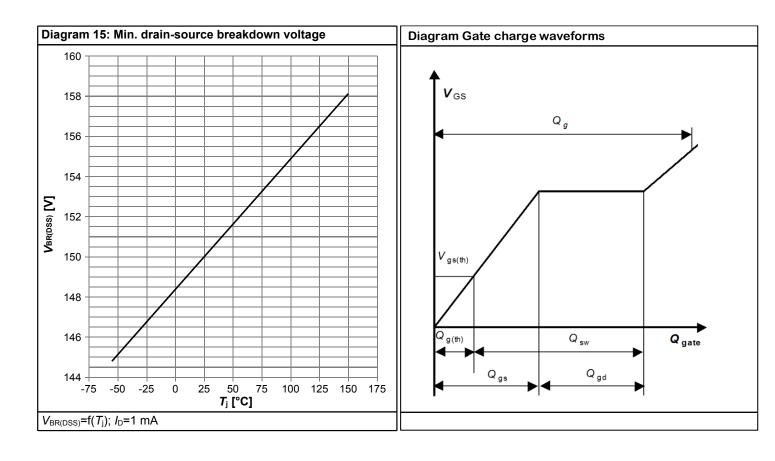






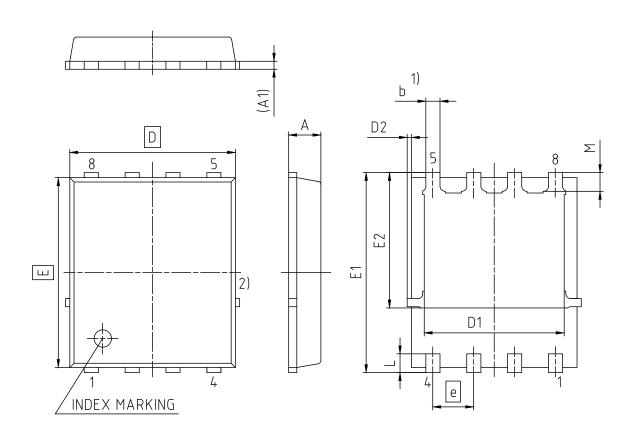








# 5 Package Outlines



1) EXCLUDING MOLD FLASH

DIMENSION

2) REMOVAL ON MOLD GATE INTRUSION 0.1 MM PROTRUSION 0.1 MM LEAD LENGTH UP TO ANTI FLASH LINE

LEAD LENGTH UP TO ANTIFLASH LINE ALL METAL SURFACES ARE PLATED, EXCEPT AREA OF CUT

MILLIMETERS

0.71

0.69

DIMENSION	MIN.	MAX.
Α	0.90	1.20
A1	0.15	0.35
b	0.34	0.54
D	4.80	5.35
D1	3.90	4.40
D2	0.00	0.22
E	5.70	6.10
E1	5.90	6.42
E2	3.88	4.31

DOCUMENT NO.					
Z8B00003332					
REVISION 08					
SCALE 10:1					
0 1 2 3mm					
EUROPEAN PROJECTION					
EUROPEAN PROJECTION					
<b>ISSUE DATE</b> 05.11.2019					

Figure 1 Outline PG-TDSON-8, dimensions in mm

0.45



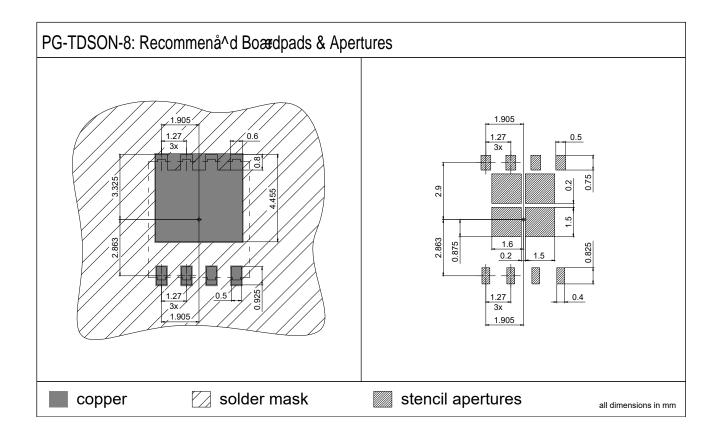


Figure 2 Outline Boardpads (TDSON-8), dimensions in mm

# OptiMOS $^{TM}$ 5 Power-Transistor , 150 V BSC088N15LS5



### Revision History

BSC088N15LS5

Revision: 2023-12-13, Rev. 2.0

#### **Previous Revision**

Revision	Date	Subjects (major changes since last revision)
2.0	2023-12-13	Release of final version

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